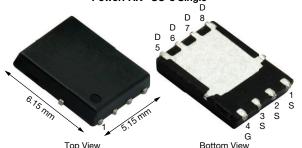
SiR4602LDP **Vishay Siliconix**

www.vishay.com

N-Channel 60 V (D-S) MOSFET PowerPAK[®] SO-8 Single



DDODUCT SUMMADY

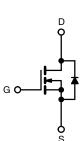
| PRODUCT SUMMART | |
|--|--------|
| V _{DS} (V) | 60 |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V | 0.0088 |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V | 0.0125 |
| Q _g typ. (nC) | 9 |
| I _D (A) | 52.1 |
| Configuration | Single |

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- Very low R_{DS} x Q_g figure-of-merit (FOM)
- Tuned for the lowest R_{DS} x Q_{oss} FOM
- 100 % R_q and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- · Primary side switch
- DC/DC converter
- Motor drive switch



N-Channel MOSFET

| ORDERING INFORMATION | |
|---------------------------------|-------------------|
| Package | PowerPAK SO-8 |
| Lead (Pb)-free and halogen-free | SiR4602LDP-T1-RE3 |

| PARAMETER Drain-source voltage | | SYMBOL | LIMIT | UNIT | |
|---|------------------------|-----------------------------------|----------------------|------|--|
| | | V _{DS} | 60 | V | |
| Gate-source voltage | | V _{GS} | ± 20 | V | |
| | T _C = 25 °C | | 52.1 | | |
| | T _C = 70 °C | 1.[| 41.7 | | |
| Continuous drain current (T _J = 150 °C) | T _A = 25 °C | I _D | 15.2 ^{b, c} | | |
| | T _A = 70 °C | 1 | 12.1 ^{b, c} | Α | |
| Pulsed drain current (t = 100 μs) | | I _{DM} | 150 | A | |
| | T _C = 25 °C | | 39.1 | | |
| Continuous source-drain diode current | T _A = 25 °C | I _S | 3.3 ^{b, c} | | |
| Single pulse avalanche current L = 0.1 mH | | I _{AS} | 15 | | |
| Single pulse avalanche energy | L = 0.1 MH | E _{AS} | 11.25 | mJ | |
| Maximum power dissipation | T _C = 25 °C | | 43 | | |
| | T _C = 70 °C | | 27.5 | w | |
| | T _A = 25 °C | P _D | 3.6 ^{b, c} | | |
| | T _A = 70 °C | 1 | 2.3 ^{b, c} | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | °C | |
| Soldering recommendations (peak temperature) ^c | | Ŭ Ŭ | 260 | | |

THEDMAL DESIGTANCE DATINGS

| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | |
|--|--------------|-------------------|---------|---------|------|--|
| Maximum junction-to-ambient ^b | t ≤ 10 s | R _{thJA} | 24 | 34 | °C/W | |
| Maximum junction-to-case (drain) | Steady state | R _{thJC} | 2.3 | 2.9 | 0/00 | |

Notes

Package limited a.

b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 70 °C/W

T_C = 25 °C g.

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COMPLIANT

HALOGEN

FREE

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not d. required to ensure adequate bottom side solder interconnection

SiR4602LDP

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| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|-------------------------|--|------|--------|--------|-------|--|
| Static | · · | | | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ | 60 | - | - | V | |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 10 mA | - | 34 | - | | |
| V _{GS(th)} temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -4.7 | - | mV/°C | |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1 | - | 2.5 | V | |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | - | - | 100 | nA | |
| | | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | - | - | 1 | μA | |
| Zero gate voltage drain current | IDSS | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 70 °C | - | - | 15 | | |
| | _ | V _{GS} = 10 V, I _D = 10 A | - | 0.0073 | 0.0088 | - Ω | |
| Drain-source on-state resistance ^a | R _{DS(on)} | V _{GS} = 4.5 V, I _D = 10 A | - | 0.0100 | 0.0125 | | |
| Forward transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 10 A | - | 47 | - | S | |
| Dynamic ^b | 1 1 | | | | | | |
| Input capacitance | C _{iss} | | - | 1185 | - | pF | |
| Output capacitance | C _{oss} | V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz | - | 185 | - | | |
| Reverse transfer capacitance | C _{rss} | | - | 7.5 | - | | |
| | | $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | - | 19.1 | 29 | nC | |
| Total gate charge | Qg | | - | 9 | 14 | | |
| Gate-source charge | Q _{qs} | | - | 4.4 | - | | |
| Gate-drain charge | Q _{gd} | | - | 2.6 | - | | |
| Output charge | Q _{oss} | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ | - | 15.5 | - | | |
| Gate resistance | R _g | f = 1 MHz | 0.3 | 0.9 | 1.5 | Ω | |
| Turn-on delay time | t _{d(on)} | $\label{eq:VDD} \begin{array}{l} V_{DD}=30 \text{ V}, \text{R}_{\text{L}}=3 \Omega, \text{I}_{\text{D}}\cong 10 \text{ A}, \\ $ | - | 12 | 24 | | |
| Rise time | tr | | - | 6 | 12 | 1 | |
| Turn-off delay time | t _{d(off)} | | - | 20 | 40 | | |
| Fall time | t _f | | - | 5 | 10 | | |
| Turn-on delay time | t _{d(on)} | | - | 18 | 36 | ns | |
| Rise time | t _r | $\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 30 \; V, \; R_{\text{L}} = 3 \; \Omega, \; I_{\text{D}} \cong 10 \; A, \\ V_{\text{GEN}} = 4.5 \; V, \; R_{\text{g}} = 1 \; \Omega \end{array}$ | - | 83 | 166 | | |
| Turn-off delay time | t _{d(off)} | | - | 20 | 40 | | |
| Fall time | t _f | | - | 7 | 14 | | |
| Drain-Source Body Diode Characteristi | cs | | | | | | |
| Continuous source-drain diode current | Is | T _C = 25 °C | - | - | 39.1 | | |
| Pulse diode forward current | I _{SM} | | - | - | 150 | A | |
| Body diode voltage | V _{SD} | I _S = 5 A, V _{GS} = 0 V | - | 0.79 | 1.1 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 21 | 42 | ns | |
| Body diode reverse recovery charge | Q _{rr} | I _F = 10 A, di/dt = 100 A/μs, | - | 12 | 24 | nC | |
| Reverse recovery fall time | t _a | $T_{\rm J} = 25 ^{\circ}{\rm C}$ | - | 11 | - | | |
| Reverse recovery rise time | t _b | | - | 10 | - | ns | |

Notes

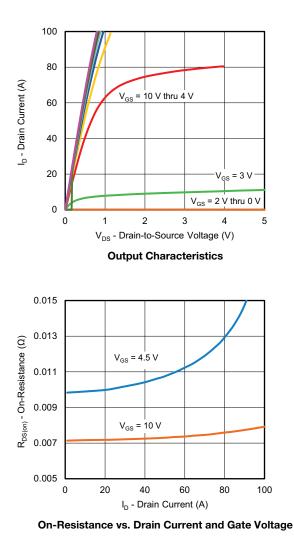
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

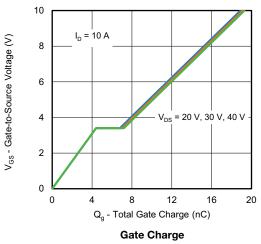
b. Guaranteed by design, not subject to production testing

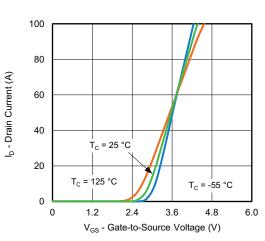
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



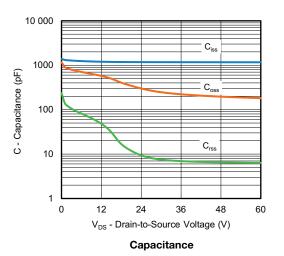
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

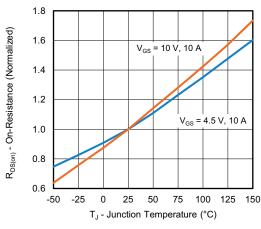






Transfer Characteristics





On-Resistance vs. Junction Temperature

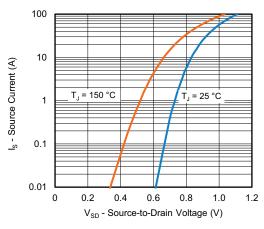
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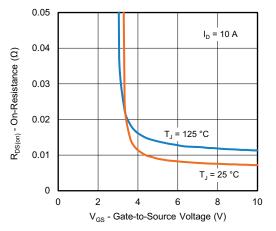
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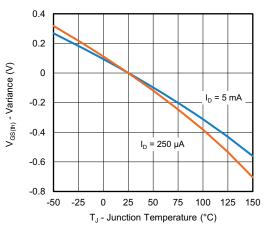
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



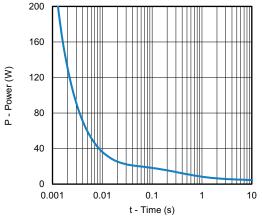
Source-Drain Diode Forward Voltage



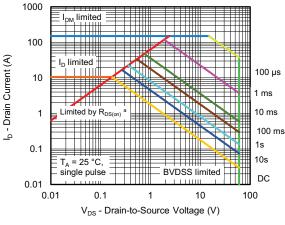
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

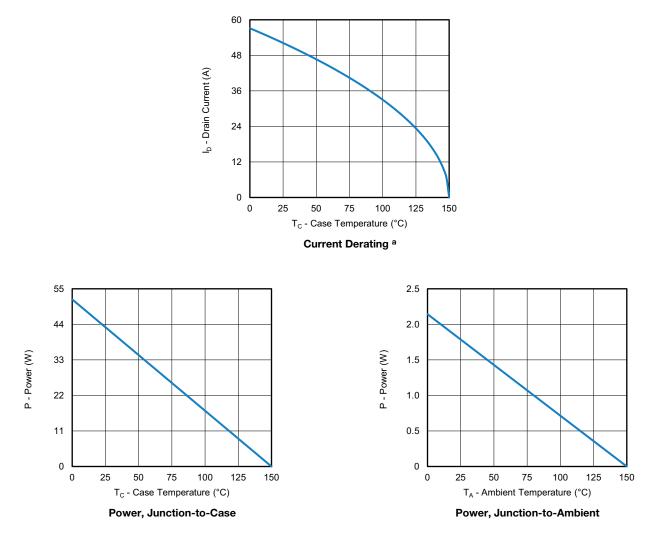
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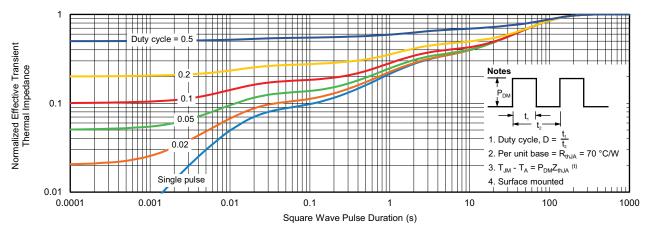


Note

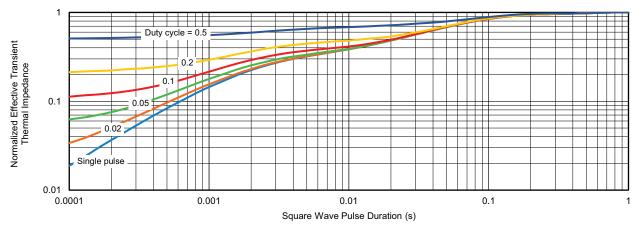
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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